

# 3NM80

**Power MOSFET**

## 3.0A, 800V N-CHANNEL SUPER-JUNCTION MOSFET

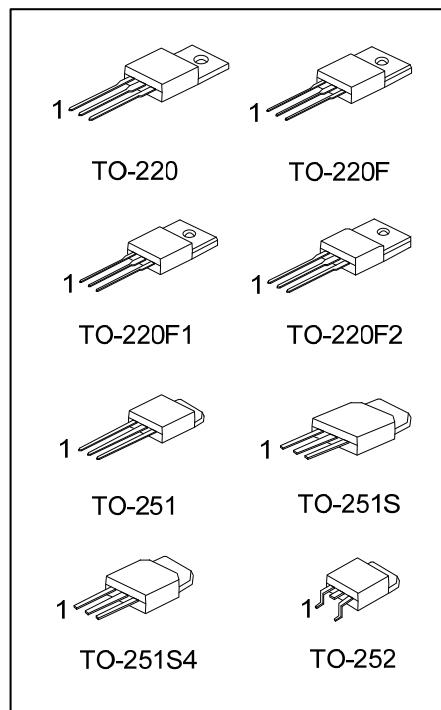
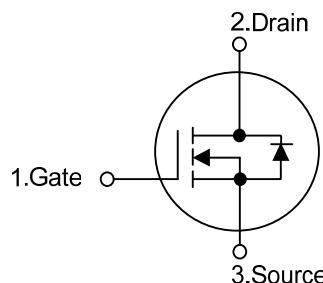
### ■ DESCRIPTION

The **UTC 3NM80** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

### ■ FEATURES

- \*  $R_{DS(ON)} \leq 2.88 \Omega$  @  $V_{GS}=10V$ ,  $I_D=1.5A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

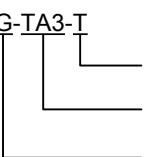
### ■ SYMBOL



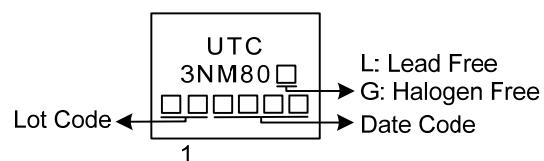
### ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
3NM80L-TA3-T	3NM80G-TA3-T	TO-220	G	D	S	Tube
3NM80L-TF3-T	3NM80G-TF3-T	TO-220F	G	D	S	Tube
3NM80L-TF1-T	3NM80G-TF1-T	TO-220F1	G	D	S	Tube
3NM80L-TF2-T	3NM80G-TF2-T	TO-220F2	G	D	S	Tube
3NM80L-TM3-T	3NM80G-TM3-T	TO-251	G	D	S	Tube
3NM80L-TMS-T	3NM80G-TMS-T	TO-251S	G	D	S	Tube
3NM80L-TMS4-T	3NM80G-TMS4-T	TO-251S4	G	D	S	Tube
3NM80L-TN3-R	3NM80G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

3NM80G-TA3-T 	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2 TF3: TO-220F, TM3: TO-251, TMS: TO-251S, TMS4: TO-251S4, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
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## ■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	800	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$I_D$	3	A
	Pulsed (Note 2)	$I_{DM}$	6	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	100	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.8	V/ns
Power Dissipation	TO-220	$P_D$	35	W
	TO-220F/TO-220F1		20	W
	TO-220F2			
	TO-251/TO-251S		21	W
	TO-251S4/TO-252			
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L=100mH,  $I_{AS}=1.4\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 3.0\text{A}$ ,  $dI/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62.5	$^\circ\text{C/W}$
	TO-220F1/TO-220F2		110	$^\circ\text{C/W}$
Junction to Case	TO-251/TO-251S	$\theta_{JC}$	3.57	$^\circ\text{C/W}$
	TO-251S4/TO-252		6.25	$^\circ\text{C/W}$
	TO-220		5.95 (Note)	$^\circ\text{C/W}$
	TO-220F/TO-220F1			
	TO-220F2			
	TO-251/TO-251S			
	TO-251S4/TO-252			

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

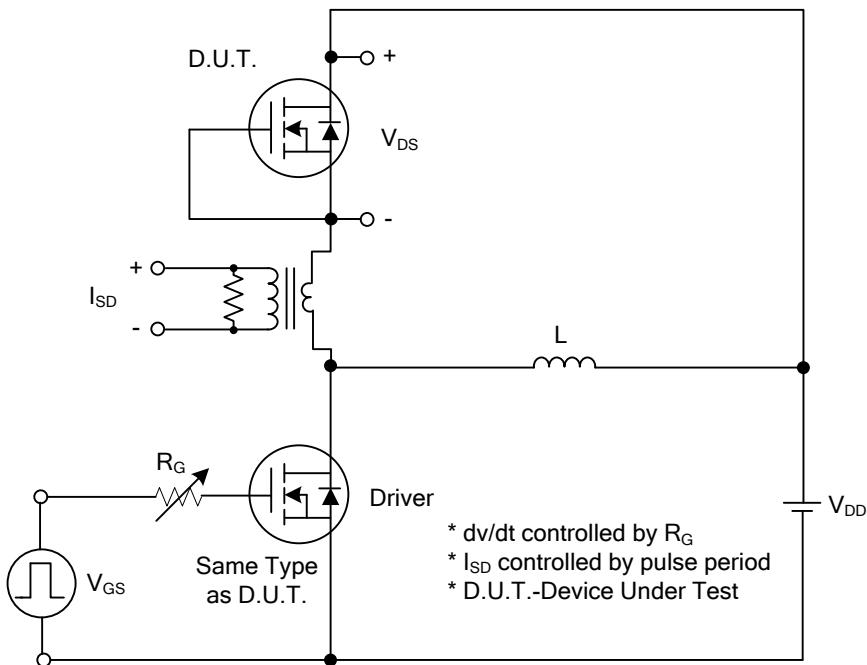
■ ELECTRICAL CHARACTERISTICS ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	800			V
Drain-Source Leakage Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=800\text{V}, \text{V}_{\text{GS}}=0\text{V}$		10		$\mu\text{A}$
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=30\text{V}, \text{V}_{\text{DS}}=0\text{V}$ $\text{V}_{\text{GS}}=-30\text{V}, \text{V}_{\text{DS}}=0\text{V}$		100	nA	
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$\text{V}_{\text{GS(TH)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=1.5\text{A}$			2.88	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$\text{C}_{\text{ISS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=50\text{V}, f=1.0\text{MHz}$		243		pF
Output Capacitance	$\text{C}_{\text{OSS}}$			29.2		pF
Reverse Transfer Capacitance	$\text{C}_{\text{RSS}}$			2.5		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge (Note 1)	$\text{Q}_G$	$\text{V}_{\text{DS}}=640\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=3\text{A}$ (Note 1,2)		18.5		nC
Gate to Source Charge	$\text{Q}_{\text{GS}}$			6.5		nC
Gate to Drain Charge	$\text{Q}_{\text{GD}}$			4		nC
Turn-ON Delay Time (Note 1)	$t_{\text{D(ON)}}$	$\text{V}_{\text{DD}}=100\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=3\text{A},$ $\text{R}_G=25\Omega$ (Note 1,2)		6		nS
Rise Time	$t_R$			17		nS
Turn-OFF Delay Time	$t_{\text{D(OFF)}}$			31		nS
Fall-Time	$t_F$			29		nS
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$\text{I}_S$			3		A
Maximum Body-Diode Pulsed Current	$\text{I}_{\text{SM}}$			6		A
Drain-Source Diode Forward Voltage (Note 1)	$\text{V}_{\text{SD}}$	$\text{I}_S=3.0\text{A}, \text{V}_{\text{GS}}=0\text{V}$		1.4		V
Body Diode Reverse Recovery Time (Note 1)	$t_{\text{rr}}$	$\text{I}_S=3.0\text{A}, \text{V}_{\text{GS}}=0\text{V}$		330		nS
Body Diode Reverse Recovery Charge	$\text{Q}_{\text{rr}}$	$d\text{I}_F/dt=100\text{A}/\mu\text{s}$		2.7		$\mu\text{C}$

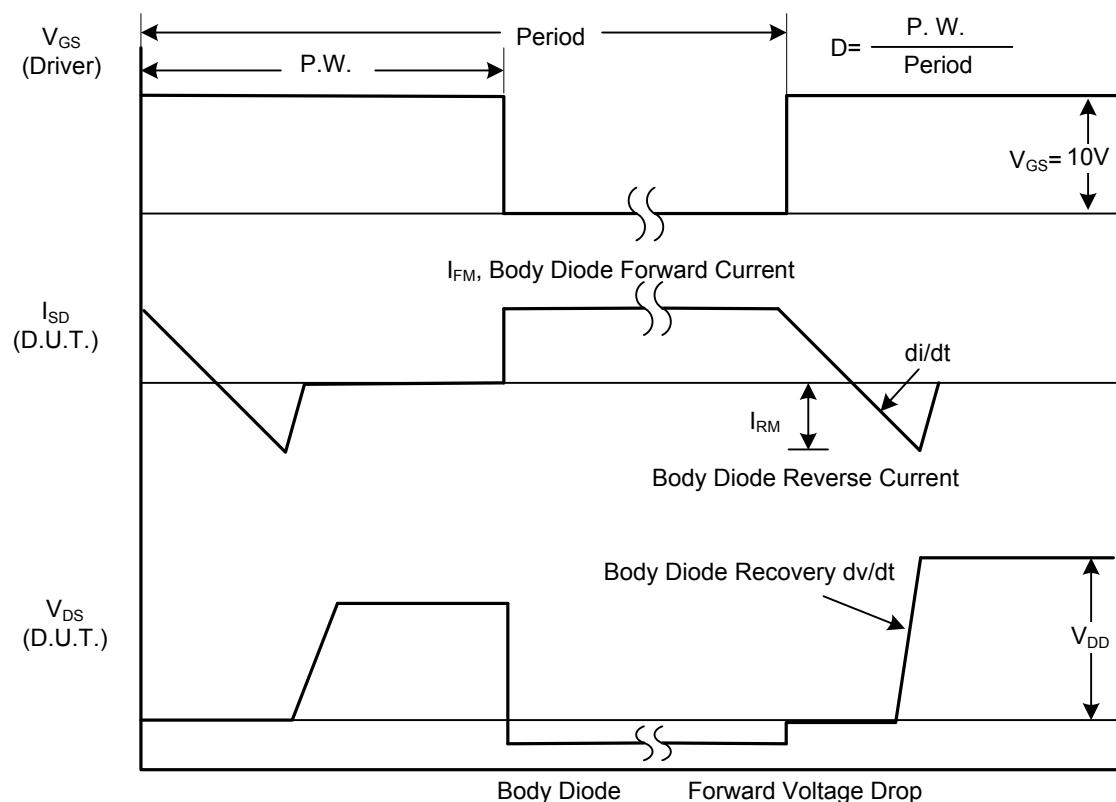
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS

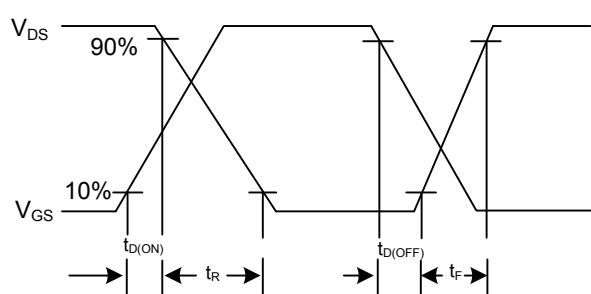
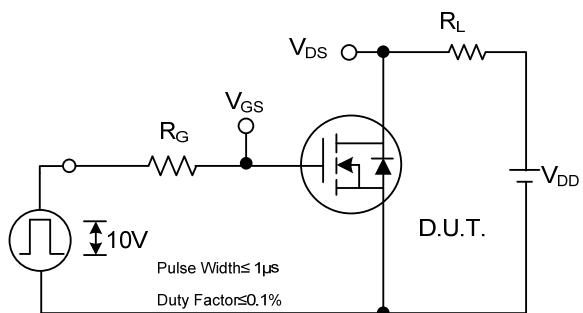


Peak Diode Recovery dv/dt Test Circuit



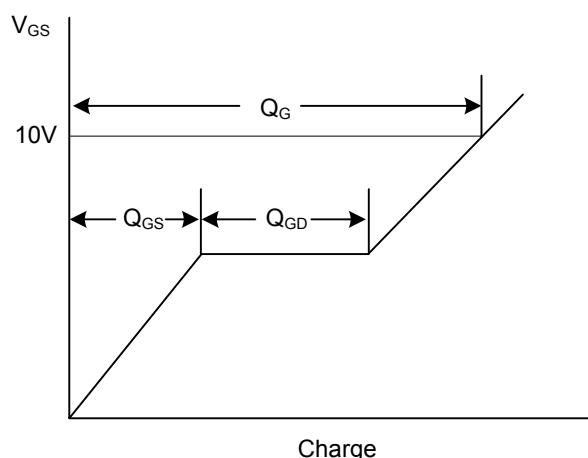
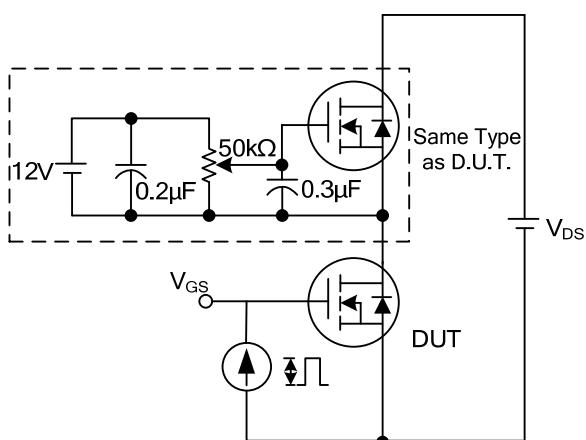
Peak Diode Recovery dv/dt Waveforms

### ■ TEST CIRCUITS AND WAVEFORMS



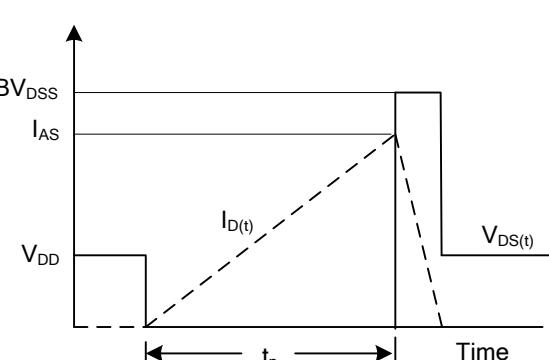
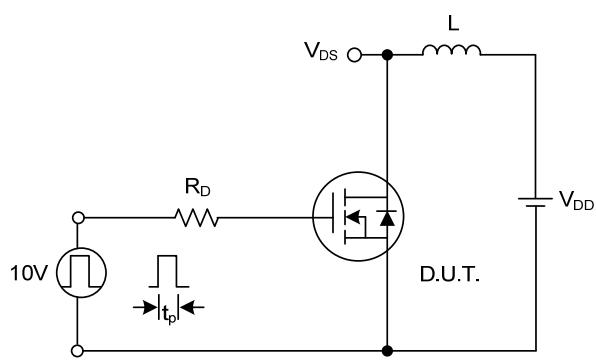
**Switching Test Circuit**

**Switching Waveforms**



**Gate Charge Test Circuit**

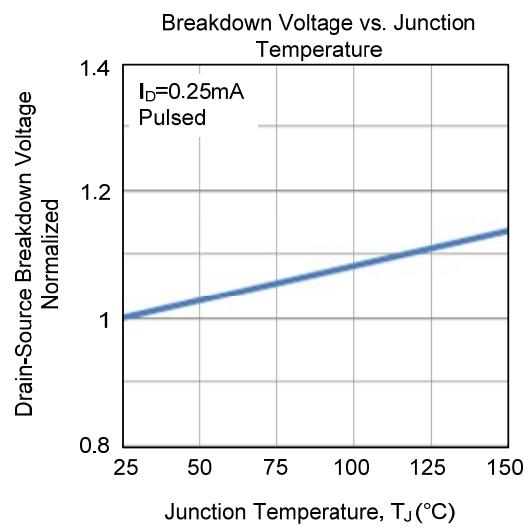
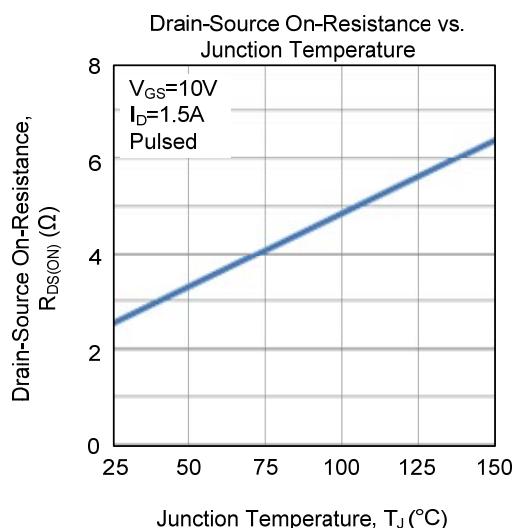
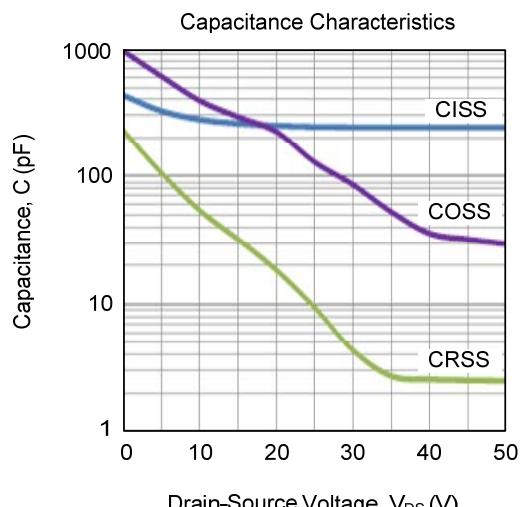
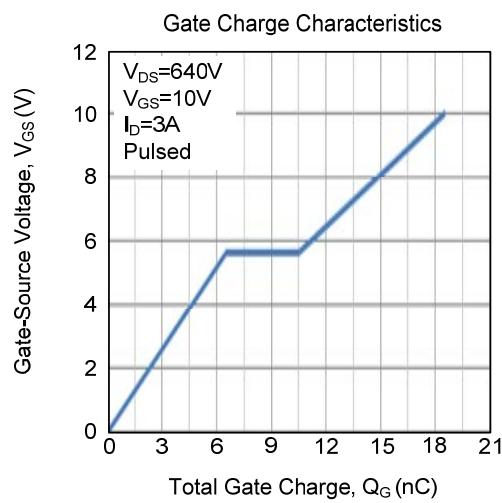
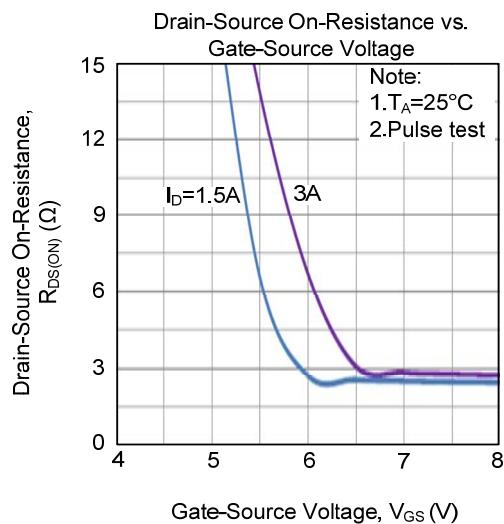
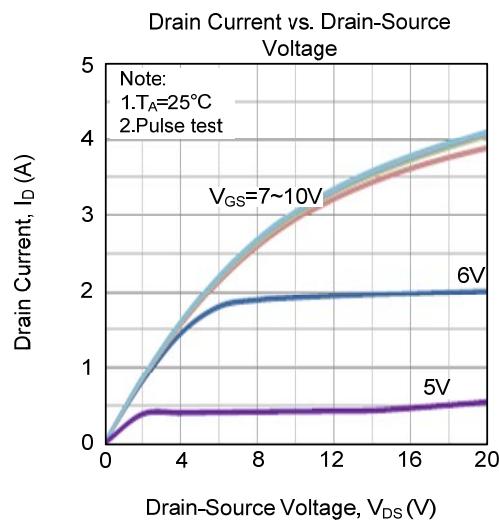
**Gate Charge Waveform**



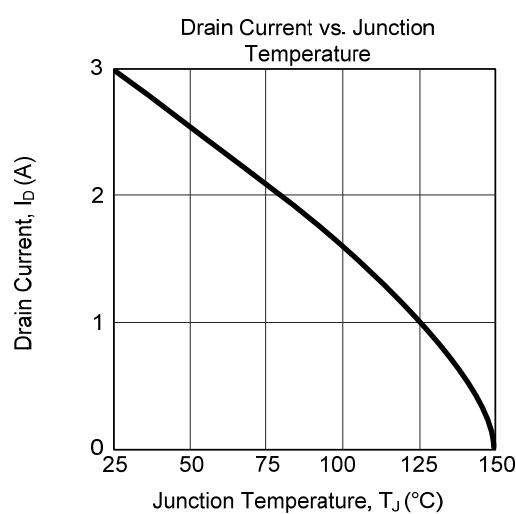
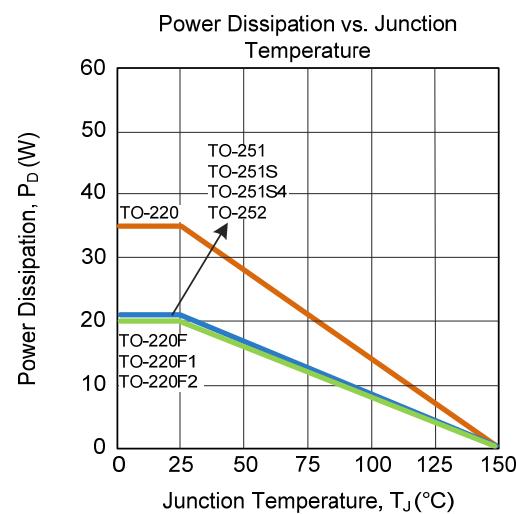
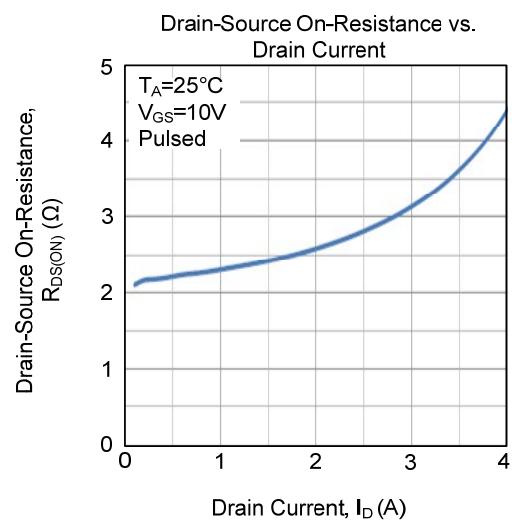
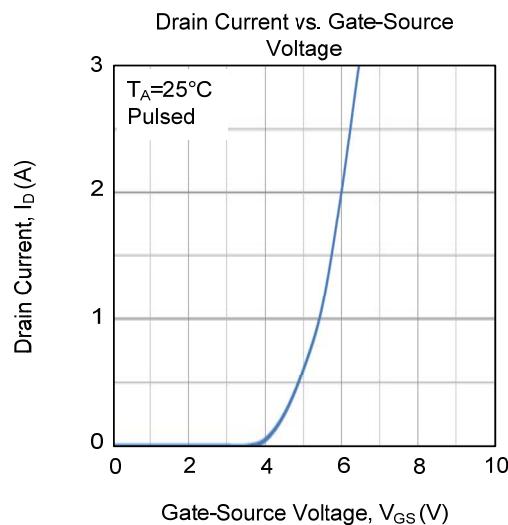
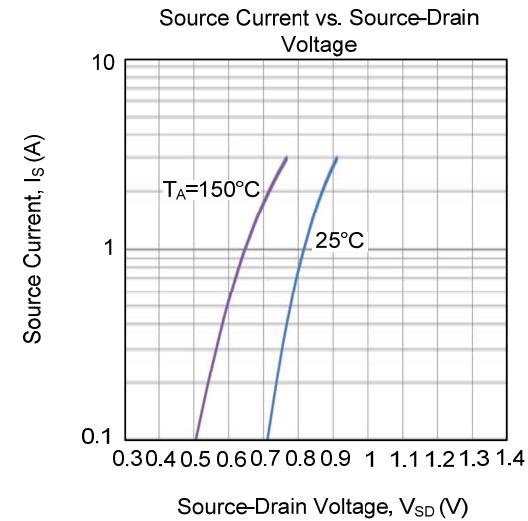
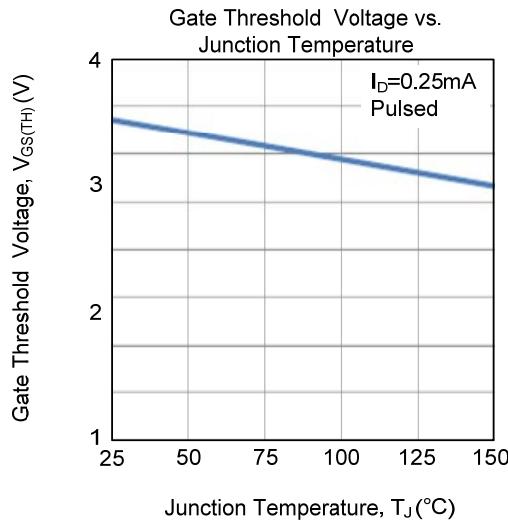
**Unclamped Inductive Switching Test Circuit**

**Unclamped Inductive Switching Waveforms**

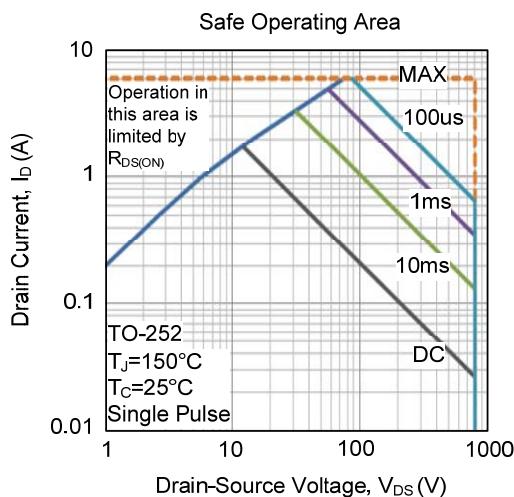
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



- TYPICAL CHARACTERISTICS (Cont.)



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